





Description:

MLCC consists of a conducting material and electrodes. To manufacture a chip-type SMT and achieve miniaturization, high density and high efficiency, ceramic condensers are used. WTC high capacitance MLCC offers low ESR and excellent frequency characteristics to be suited for coupling and decoupling applications in circuit. The high dielectric constant material X7R, X5R and Y5V are used for this series product.

Features:

- · Small size with high capacitance.
- · Capacitor with lead-free termination (pure Tin).

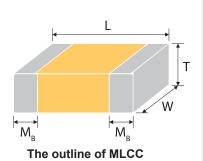
Applications:

- · Digital circuit coupling or decoupling applications.
- For high frequency and high-density type power suppliers.
- · For bypassing.

How To Order:

МС	31	Х	225	K	100	С	Т
IVIC	<u>Size</u>	Dielectric	<u>Capacitance</u>	<u>Tolerance</u>	Rated Voltage	<u>Termination</u>	Packaging style
Multicomp	Inch (mm) 0402 (1005) 0603 (1608) 0805 (2012) 1206 (3216) 1210 (3225) 1812 (4532)	B=X7R X=X5R S=X6S F=Y5V	Two significant digits followed by no. of zeros. And R is in place of decimal point. Eg.: 106 = 10×10 ⁶ = 10µF	K=±10% M=±20% Z=-20/+80%	Two significant digits followed by no. of zeros. And R is in place of decimal point. 6R3=6.3V DC 100=10V DC 160=16V DC 250=25V DC 500=50V DC 101=100V DC	C=Cu/Ni/Sn	T=7" reeled G=13" reeled

External Dimensions:



Size Inch (mm)	L (mm)	W (mm)	T (mm)/Symbol Remark			M _B (mm)
0402 (1005)	1 ±0.05	0.5 ±0.05	0.5 ±0.05	N	#	0.25
0402 (1005)	1 ±0.2	0.5 ±0.2	0.5 ±0.2	Е	#	+0.05/-0.1
	1.6 ±0.1	0.8 ±0.1	0.8 ±0.07	S		
0603 (1608)	1.6 +0.15/- 0.1	0.8 +0.15/- 0.1	0.8 +0.15/- 0.1	Х		0.4±0.15
	1.6 ±0.2* ¹ 0.8 ±0.2		0.8 ±0.2* ¹			
	2 +0 15	1 25 ±0 1	0.8 ±0.1	В		
0805 (2012)	2 ±0.15 1.25 ±0.1		1.25 ±0.1	D	#	0.5 ±0.2
	2 ±0.2	1.25 ±0.2	1.25 ±0.2	Ī	#	





Size Inch (mm)	L (mm)	W (mm)	T (mm)/Syml	ool	Remark	M _B (mm)
	3.2±0.15		0.95±0.1	С	#	
	3.2±0.15	1.6±0.15	1.25±0.1	D	#	
1206 (3216)	3.2±0.2		1.15±0.15	J	#	0.6±0.2
	3.2±0.2	1.6±0.2	1.6±0.20	G	#	
	3.2+0.3/-0.1	1.6+0.3/-0.1	1.6+0.3/-0.1	Р	#	
	3.2±0.3	2.5±0.2	0.95±0.1	С	#	
	3.2±0.3	2.0±0.2	1.25±0.1	D	#	
1210 (3225)	3.2±0.4	2.5±0.3	1.6±0.2	G	#	0.75±0.25
			2±0.2	K	#	
			2.5±0.3	М	#	
	4.5±0.4	2 210 2	1.25±0.1	D	#	
1912 (4522)	4.3±0.4	3.2±0.3	2±0.2	K	#	0.75+0.25
1812 (4532)	4.510.4	2 210 4	2.5±0.3	М	#	0.75±0.25
	4.5±0.4	3.2±0.4	2.8±0.3	U	#	

[#] Reflow soldering only is recommended.

General Electrical Data:

Dielectric	X7R	X5R	X6S	Y5V		
Size		0402, 0603, 0805,	1206, 1210, 1812			
Capacitance range*	0.56μF to 47μF	0.027μF to 100μF	0.47μF to 100μF	1μF to 100μF		
Capacitance tolerance**		Z (-20/+80%)				
Rated voltage (WVDC)		6.3V, 10V, 16V,	25V, 50V, 100V			
DF(Tan δ)*		Not	te 1			
Operating temperature	-55 to +125°C	-55 to +85°C	-55 to +105°C	-25 to +85°C		
Capacitance characteristic	±1	+30/-80%				
Termination	Ni/Sn (lead-free termination)					

^{*} Measured at 1±0.2Vrms, 1kHz±10% for C≤10μF; 0.5±0.2Vrms, 120Hz±20% for C>10μF, 30~70% related humidity, 25°C ambient temperature for X7R, X5R and at 20°C for Y5V.



^{*1 :} For 0603/Cap≥10µF products

^{**} Preconditioning for Class II MLCC: Perform a heat treatment at 150±10°C for 1 hour, then leave in ambient condition for 24±2 hours before measurement.



Note 1:

X7R/X5R/X6S

Rated Vol.	D.F. ≦		Exception of D.F.≦	
≧100V	≦2.5%	≦3%	1206≧0.47µF	
= 1000	=2.5%	≦5%	0805>0.1μF, 0603≥0.068μF	
		≦3%	0201(50V); 0603≧0.047μF; 0805≧0.18μF;1206≧0.47μF	
50V	≦2.5%	≦5%	1210≧4.7µF	
		≦10%	0402≧0.1μF;0603≧1μF;0805≧1μF;1206≧2.2μF; 1210≧10μF;TT series	
35V	≦3.5%	≦10%	0603≧1μF;0805≥2.2μF; 1210≧10μF	
		≦5%	0201 ≥ 0.01μF;0805 ≥ 1μF; 1210 ≥ 10μF	
	≦3.5%	≦7%	0603≧0.33μF; 1206≧4.7μF	
25V		≦3.5%	≦10%	0402≧0.10μF;0603≧0.47μF; 0805≧2.2μF; 1206≧6.8μF ; 1210≧22μF ; TT series
		≦12.5	%0402≧1μF	
16V	≦3.5%	≦5%	0201 \ge 0.01 μF;0402 \ge 0.033 μF; 0603 \ge 0.15 μF; 0805 \ge 0.68 μ 1206 \ge 2.2 μF;1210 \ge 4.7 μF	
100	= 3.5%	≦10%	0201≥0.1μF;0402≥ 0.22uF; 0603≥0.68μF;0805≥2.2μF; 1206≥4.7μF; 1210≥22μF; TT series	
10V	≦5%	≦10%	0201 \ge 0.012 µF;0402 \ge 0.33 µF;0603 \ge 0.33 µF; 0805 \ge 2.2 µF; 1206 \ge 2.2 µF;1210 \ge 22 µF; TT series	
		≦15%	0201≧0.1μF; 0402≧1μF	
6.3V	≦10%	≦15%	0201≧0.1μF;0402≧1μF;0603≧10μF; 0805≧4.7μF; 1206≧47μF :1210≧100μF; TT series	
		≦20%	0402≧2.2µF	
4V	≦15%			

Y5V

Rated vol.	D.F.≦		Exception of D.F.≦
≧50V	5%	7%	0603≧0.1μF; 0805≧0.47μF; 1206≧4.7μF
35V	7%		
25V	5%	7%	0402 \ge 0.047 μ F;0603 \ge 0.1 μ F; 0805 \ge 0.33 μ F;1206 \ge 1 μ F; 1210 \ge 4.7 μ F
		9%	$0402 \ge 0.068 \mu F; 0603 \ge 0.47 \mu F; 1206 \ge 4.7 \mu F; 1210 \ge 22 \mu F$
16V (C<1.0µF)	7%	9%	0402≧0.068μF; 0603≧0.68μF
16ν (С<1.0με)	1 70	12.5%	0402≧0.22μF
16V (C≧1.0μF)	9%	12.5%	0603≥2.2μF; 0805≥3.3μF; 1206≥10μF; 1210≥22μF; 1812≥47μF
10V	12.5%	20%	0402≧0.47μF
6.3V	20%		





Packaging Dimension And Quantity:

Size	Thickness (mm)/S	v m h a l	Pape	r tape	Plasti	c tape
Size	Thickness (mm)/Symbol		7" reel	13" reel	7" reel	13" reel
0402 (1005)	0.50±0.05	N	10k	50k	-	-
0402 (1005)	0.50±0.20	E	10k	-	-	-
0603 (1608)	0.80±0.07	S	4k	15k	-	-
0003 (1008)	0.80±0.20	Х	4k	15k	-	-
	0.80±0.10	В	4k	15k	-	-
0805 (2012)	1.25±0.10	D	-	-	3k	10k
	1.25±0.20	I	-	-	3k	10k
	0.95±0.10	С	-	-	3k	10k
	1.15±0.15	J	-	-	3k	10K
1206 (3216)	1.25±0.10	D	-	-	3k	10k
	1.60±0.20	G	-	-	2k	10k
	1.60+0.30/-0.10	Р	-	-	2k	9k
	0.95±0.10	С	-	-	3k	10k
	1.25±0.10	D	-	-	3k	10k
1210 (3225)	1.60±0.20	G	-	-	2k	-
	2.00±0.20	K	1	-	1k	6k
	2.50±0.30	М	-	-	1k	6k
	1.25±0.10	D	-	-	1k	5k
1812 (4532)	2.00±0.20	K	-	-	1k	-
1012 (4532)	2.50±0.30	М	-	-	0.5k	3k
	2.80±0.30	U	-	-	0.5k	-

Unit : pieces

No	Item	Test Condition	Requirements
1	Visual and Mechanical	-	No remarkable defect. Dimensions to conForm to individual specification sheet.



General Purpose High Capacitance Multilayer SMD Ceramic Capacitor 0402 to 1812 Sizes, X7R, X5R, X6S & Y5V Dielectrics



No	Item	Test Condition	Requirements					
2	Capacitance		*Shall not exceed the limits given in the detailed spec.					
		NP0: Cap≥30pF, Q≥1000; Cap<30pF,Q≥400+20C X7R,X5R,X6S:						
			Rated vol.	D.F.	≦		Exception of D.F. ≦	
			>400)/	-0.5	.,/	≦3%	1206≧0.47µF	
			≧100V	≦2.5	70	≦5%	0805>0.1μF, 0603≧0.068μF	
						≦3%	0201(50V); 0603≧0.047µF; 0805≧0.18µF;1206≧0.47µF	
			≧50V	 ≦2.5	5% T	≦5%	1210≧4.7µF	
			=001	=2.0		≦10%	0402≥0.1μF; 0603≥1μF; 0805≥1μF;1206≥4.7μF; 1210≥10μF TT series	
			35V	≦3.5	5%	≦10%	0603≧1μF; 0805≥2.2μF; 1210≧10μF	
						≦5%	0201≧0.01μF;0805≧1μF; 1210≧10μF	
		Class I: NP0				≦7%	0603≧0.33μF; 1206≧4.7μF	
		Cap≤1000pF 1.0±0.2Vrms, 1MHz±10% Cap>1000pF 1.0±0.2Vrms, 1KHz±10%	25V	≦3.5		≦10%	0402≧0.10μF;0603≧0.47μF;0805≧2.2 μF; 1206≧6.8μF ; 1210≧22μF; TT series	
		Class II: X7R, X5R, X6S,Y5V Cap≤10µF, 1.0±0.2Vrms, 1kHz±10% ** Cap>10µF, 0.5±0.2Vrms, 120Hz±20%			≦	≦12.5%	0402≧1µF	
			16V			≦5%	0201≥0.01μF; 0402≥0.033μF; 0805≥0.68μF;1206≥2.2μF;1210≥4.7μF	
	Q/ D.F.	** Test condition: 0.5±0.2Vrms,		≦3.5%	- 1	≦10%	0201≥0.1μF; 0402≥0.47μF; 0603≥0.68μF;0805≥2.2μF; 1206≥4.7μF; 1210≥22μF; TT series	
	(Dissipation Factor)	1KHz±10% X7R: 0603≧225(10V), 0805=106(6.3V&10V)	10V	≦5%		≦10%	0201≧0.012μF 0402≧0.33μF; 0603≧0.33μF; 0805≧2.2μF; 1206≧2.2μF; 1210≧22μF; TT series	
		X5R: 01R5≧103, 0201≧224		İ		≦15%	0201≧0.1µF; 0402≧1µF	
		(6.3V,10V), 0402≧475 (6.3V), 0402≧225(10V), 0603=106 (6.3V,10V),	6.3V	≦10°		≦15%	0201≧0.1μF;0402≧1μF;0603≧10μF; 0805≧4.7μF; 1206≧47μF :1210≧100μF; TT series	
		TT18X ≧475(10V), TT15X series				≦20%	0402≧2.2μF	
		X6S:0201≧224 (6.3V),0402≧225 (6.3V),	4V	≦15°	%	-	-	
		(6.5 7),	Y5V:					
			Rated vol.	D).F.≦		Exception of D.F. ≦	
			≧50V		5%	7%	0603≧0.1μF; 0805≧0.47μF; 1206≧4.7μF	
			35V		7%	-	-	
			25V		5%	7%	0402≧0.047μF;0603≧0.1μF; 0805≧0.33μF;1206≧1μF; 1210≧4.7μF	
			250		J /0	9%	0402≧0.068μF; 0603≧0.47μF; 1206≧4.7μF; 1210≧22μF	
			16V		7%	9%	0402≧0.068μF; 0603≧0.68μF	
			(C<1µF	-)	1 /0	12.5%	0402≧0.22µF	
			16V (C≧1.0µ	ıF)	9%	12.5%	0603≥2.2μF; 0805≥3.3μF; 1206≥10μF; 1210≥22μF; 1812≥47μF	
			10V	12	2.5%	20%	0402≧0.47µF	
			6.3V	2	20%	-	-	



General Purpose High Capacitance Multilayer SMD Ceramic Capacitor 0402 to 1812 Sizes, X7R, X5R, X6S & Y5V Dielectrics



No	Item	Test Condition		Requirements				
4	Dielectric Strength	To apply voltage (≤100V) 250%. Duration: 1 to 5 sec. Charge and discharge current less than 50mA.	No evidence of damage or flash over during test.					
				r RxC≧500Ω-F whicheve (X7R, X5R, X6S, Y5V)	r is smalle	er.		
				Rated voltage		Insulation Resistance		
			100V: X	7R				
			50V:060 1210≥4	03≥1µF;0805≥1µF;1206≥4.7∣ 7µF	μF;			
			35V:080	05≥2.2µF;1210≧10µF		100		
5	Insulation	To apply rated voltage for max. 120	11	02≥1µF;0603≥2.2µF;0805≥2. 0µF;1210≥10µF	.2μF;	10G or RxC≧100ΩF whichever is		
3	Resistance	sec.	16V:0402≥0.22µF;0603≥1µF;0805≥2.2µF; 1206≥10µF;1210≥47µF			smaller.		
			10V:0201≥47nF;0402≥0.47µF;0603≥0.47µF; 0805≥2.2µF; 1206≥4.7µF;1210≥47µF			1		
			6.3V ; 4	V				
			50V: 04	02≥0.1µF		10GΩ or		
			35V:060)3≥1µF		RxC≧50 Ω-F		
			10V:060)3≥10µF		whichever is		
			4V:0603	3≥22µF; 0805≥47µF		smaller.		
		With no electrical load.	<u> </u>					
		T.C. Operating Temp	T.C.	Capacitance Change				
		NPO -55~125°C at 25°C	NPO	Within ±30ppm/°C				
6	Temperature	X7R -55~125°C at 25°C	X7R	Within ±15%				
	Coefficient	X5R -55~ 85°C at 25°C	X5R	Within ±15%				
		X6S -55~105°C at 25°C	X6S	Within ±22%				
		Y5V -25~ 85°C at 20°C	Y5V	Within +30%/-80%				
7	Adhesive Strength of Termination	Pressurizing force: 5N (≤0603) and 10N (>0603) * Test time: 10±1 sec.	No remarkable damage or removal of the terminations.					
8	Vibration Resistance	Vibration frequency: 10~55 Hz/min. Total amplitude: 1.5mm Test time: 6 hrs. (Two hrs each in three mutually perpendicular directions.) Measurement to be made after keeping at room temp. for 24±2 hrs.	No remarkable damage. Cap change and Q/D.F.: To meet initial spec.					



No	Item	Test Condition		Requirements		
9	Solderability	Solder temperature: 235±5°C Dipping time: 2±0.5 sec.		95% min. coverage of all metalized area.		
10.	Bending Test	The middle part of substrate spressurized by means of the pizing rod at a rate of about 1 resecond until the deflection be 1 mm and then the pressure smaintained for 5±1 sec. Meast to be made after keeping at refor 24±2 hrs.	ressur- nm per comes hall be urement	No remarkable damage. Cap change: NP0: within ±5% or 0.5pF whichever is larger X7R, X5R, X6S: within ±12.5% Y5V: within ±30% (This capacitance change means the change of capacitance under specified flexure of substrate from the capacitance measured before the test.)		
11	Resistance to Soldering Heat	Solder temperature: 260±5°C Dipping time: 10±1 sec Preheating: 120 to 150°C for ute before immerse the capace eutectic solder. Before initial measurement (Conly): Perform 150+0/-10°C for then set for 24±2 hrs at room Measurement to be made after at room temp. for 24±2 hrs.	tor in a lass II r 1 hr and emp.	No remarkable damage. Cap change: NP0: within ±2.5% or 0.25pF whichever is larger X7R, X5R, X6S: within ±7.5% Y5V: within ±20% Q/D.F., I.R. and dielectric strength: To meet initial requirements. 25% max. leaching on each edge.		
12	Temperature Cycle	Conduct the five cycles according temperatures and time. Step Temp. (°C) 1 Min. operating temp. +0/2 2 Room temp. 3 Max. operating temp. +3/2 4 Room temp. Before initial measurement (Conly): Perform 150+0/-10°C for then set for 24±2 hrs at room Measurement to be made after at room temp. for 24±2 hrs.	Time (min.) 3 30±3 2~3 -0 30±3 2~3 ass II r 1 hr and emp.	No remarkable damage. Cap change: NP0: within ±2.5% or 0.25pF whichever is larger X7R, X5R, X6S: within ±7.5% Y5V: within ±20% Q/D.F., I.R. and dielectric strength: To meet initial requirements.		





No	Item	Test Condition	Requirements				
			Cap cha NP0: wi X7R, X3 TT seriet **10V: 0 Y5V: ≥1 Q/D.F. v NP0: M Less tha	ange: ithin ±5% 5R, X6S es & C≥ 0603≧4. 0V, with value: ore than	: ≥10V** 1uF,withi 7µF;040 in ±30% 30pF Q Q≥200+	F whichever is larger ,within ±12.5%; ≤6.3V within ±25%; in ±25% 2≥1µF;0201≥0.1µF, within ±25%; ; ≤6.3V, within +30/-40% ≥350, 10pF≤C≤30pF, Q≥275+2.5C	
			Rated vol.	D.F.≦		Exception of D.F. ≦	
					≦6%	1206≧0.47μF	
		at) Before Initial measurement (Class II	≧100V	≦3%	≦7.5%	0805>0.1μF, 0603≧0.068μF	
					≦6%	0201(50V); 0603≥0.047μF; 0805≥0.18μF;1206≥0.47μF	
			 ≥50V	≦3%	≦10%	1210≧4.7µF	
13	Humidity (Damp Heat)				≦20%	0402≧0.1μF; 0603≧1μF; 0805≧1μF;1206≧4.7μF; 1210≧10μF TT series	
	Steady State		35V	≦5%	≦20%	0603≧1μF; 0805≥2.2μF; 1210≧10μF	
					≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF	
					≦14%	0603≧0.33μF; 1206≧4.7μF	
			25V	≦5%	≦15%	0402≧0.10μF;0603≧0.47μF;0805≧2.2 μF; 1206≧6.8μF ; 1210≧22μF; TT series	
					≦20%	0402≧1µF	
					≦10%	0201≥0.01μF; 0402≥0.033μF; 0805≥0.68μF;1206≥2.2μF;1210≥4.7μF	
			16V	≦5%	≦15%	0201≥0.1μF; 0402≥0.47μF; 0603≥0.68μF;0805≥2.2μF; 1206≥4.7μF; 1210≥22μF; TT series	
			10V	≦7.5%	≦15%	0201≥0.012μF 0402≥0.33μF; 0603≥0.33μF; 0805≥2.2μF; 1206≥2.2μF; 1210≥22μF	
					≦20%	0201≧0.1μF; 0402≧1μF TT series	
			6.3V	≦15%	≦30%	0201≧0.1μF;0402≥1μF;0603≥10μF; 0805≥4.7μF; 1206≥47μF :1210≥100μF; TT series	
			4V	≦20%	-	-	



No	Item	Test Condition	Requirements							
			Y5V:							
			Rated vol.	of D.F. ≦						
			≧50V	7.5%	10%	0603≧0.1µF; 080	05≧0.47μF; 1206≧4.7μF			
			35V	10%	-	-				
			25V	7.5%	10%	0402≧0.047µF;0 0805≧0.33µF;12	603≧0.1μF; 06≧1μF; 1210≧4.7μF			
			250	7.5%	15%	0402≧0.068µF; 0 1206≧4.7µF; 121				
			16V 10% 12.5% 0402≧0.06		0402≧0.068µF; 0	0603≧0.68µF				
			(C<1µF)	10 /6	20%	0402≧0.22µF				
			16V (C≧1.0µF)	12.5%	20%	0603≧2.2μF; 0805≧3.3μF; 1206≧10μF; 1210≧22μF; 1812≧47μF				
			10V	20%	30%	0402≧0.47µF				
			6.3V	30%	-	-				
13			*I.R.: ≥10V Class II (X			2-F whichever is smaller. 5, Y5V)				
	Rated volt					Rated voltage				
			50V: 0402≥ 1206≥4.7µ			F;0805≥1µF;				
			35V: 0603	≥1µF; 08	305≥2.2µ	uF;1210≧10μF				
			25V:0402≥ 1206≥10µF			F;0805≥2.2μF;	1GΩ or RxC≧10 Ω-F			
			16V:0402≥ 1206≥10µF			ıF;0805≥2.2μF;	whichever is smaller.			
			10V:0201≥ μF;0805≥2		102≥0.47	7μF;0603≥0.47				
			1206≥4.7µ	F;1210≥	:47μF					
			6.3V ; 4V							
14	Humidity (Damp Heat) Load	Damp Heat) Before initial measurement (Class II TT series & C≥ 1uF,within ±25%								



No	Item	Test Condition	Requirements							
			X7R, X5	5R, 2	X6S:					
			Rated vol.	D.I	F.≦		Exception of D.F. ≦			
						≦6%	1206≧0.47µF			
			≧100V	≦₹	3%	≦7.5%	0805>0.1μF, 0603≧0.068μF			
						≦6%	0201(50V); 0603≧0.047µF; 0805≧0.18µF;1206≧0.47µF			
			<u> </u> ≥50V	_ ≤:	3% 	≦10%	1210≧4.7µF			
			=001			≦20%	0402≥0.1μF; 0603≥1μF; 0805≥1μF;1206≥4.7μF; 1210≥10μF TT series			
			35V	≦!	5%	≦20%	0603≧1μF; 0805≥2.2μF; 1210≧10μF			
						≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF			
					L	≦14%	0603≧0.33μF; 1206≧4.7μF			
			25V	≦!	5%	≦15%	0402≧0.10μF;0603≧0.47μF;0805≧2.2 μF; 1206≧6.8μF ; 1210≧22μF; TT series			
						≦20%	0402≧1µF			
						≦10%	0201≧0.01μF; 0402≧0.033μF; 0805≧0.68μF;1206≧2.2μF;1210≧4.7μF			
	l locacialita		16V	≦!	5%	≦15%	0201≧0.1μF; 0402≧0.47μF; 0603≧0.68μF;0805≧2.2μF; 1206≧4.7μF; 1210≧22μF; TT series			
14	Humidity (Damp Heat) Load		10V	≦7.5%		≦15%	0201≧0.012μF 0402≧0.33μF; 0603≧0.33μF; 0805≧2.2μF; 1206≧2.2μF; 1210≧22μF; TT series			
			İ			≦20%	0201≧0.1μF; 0402≧1μF			
			6.3V	≦1	5%	≦30%	0201≥0.1μF;0402≥1μF;0603≥10μF; 0805≥4.7μF; 1206≥47μF:1210≥100μF; TT series			
			4V	≦2	20%	-	-			
			Y5V:	′5V:						
			Rated vol.		D.F.≦		Exception of D.F. ≦			
			≧50V		7.5%	10%	0603≧0.1μF; 0805≧0.47μF; 1206≧4.7μF			
			35V		10%	-	-			
			25V	T	7.5%	10%	0402≧0.047μF;0603≧0.1μF; 0805≧0.33μF;1206≧1μF; 1210≧4.7μF			
			250		1.5%	15%	0402≧0.068μF; 0603≧0.47μF; 1206≧4.7μF; 1210≧22μF			
			16V	\dashv	10%	12.5%	0402≧0.068μF; 0603≧0.68μF			
			(C<1µF)	10%	20%	0402≧0.22µF			
			16V (C≧1.0µ	16V (C≧1.0μF)		20%	0603≧2.2μF; 0805≧3.3μF; 1206≧10μF; 1210≧22μF; 1812≧47μF			
			10V		20%	30%	0402≧0.47μF			
	l		6.3V		30%	-	-			





No	Item	Test Condition	Requirements					
			*I.R.: ≥10V, 500MΩ or 25 Ω-F whichever is smaller. Class II (X7R, X5R, X6S, Y5V)					
			Rated voltage	Insulation Resistance				
			100V: X7R					
			50V: 0402≥0.1μF;0603≥1μF;0805≥1μF; 1206≥4.7μF;1210≥4.7μF					
l	Humidity		35V: 0603≥1µF; 0805≥2.2µF;1210≥10µF					
14	(Damp Heat) Load		25V:0402≥1µF;0603≥2.2µF;0805≥2.2µF; 1206≥10µF;1210≥10µF	500GΩ or RxC≧5 Ω-F				
			16V:0402≥0.22µF;0603≥1µF;0805≥2.2µF; 1206≥10µF;1210≥47µF	whichever is smaller.				
			10V:0201≥47nF;0402≥0.47µF;0603≥0.47 µF;0805≥2.2µF;					
			1206≥4.7µF;1210≥47µF					
			6.3V ; 4V					
15.	High Temperature Load (Endurance)	*Test temp.: NP0, X7R/X7E: 125±3°C X6S: 105±3°C X5R, Y5V: 85±3°C *Test time: 1000+24/-0 hrs. *To apply voltage: 1) ≦% of rated voltage. 2) 10V≦Ur<500V: 200% of rated voltage. 3) 500V: 150% of rated voltage. 4) Ur≧630V: 120% of rated voltage.	No remarkable damage. Cap change: NP0: $\pm 3.0\%$ or ± 0.3 pF whichever is larger X7R, X5R, X6S: $\geq 10V^{**}$,within $\pm 12.5\%$; $\leq 6.3V$ within $\pm 25\%$; TT series & C ≥ 1 uF,within $\pm 25\%$ **10V: $0603 \geq 4.7$ µF; $0402 \geq 1$ µF; $0201 \geq 0.1$ µF, within $\pm 25\%$; Y5V: $\geq 10V$, within $\pm 30\%$; $\leq 6.3V$, within $\pm 30/-40\%$ Q/D.F. value: NP0: More than 30pF, Q ≥ 350 10 pF $\leq C < 30$ pF, Q $\geq 275 + 2.5C$ Less than 10 pF, Q $\geq 200 + 10$ C					



		5) 1009 rang Size 0201 0402	Dielectric X5R/X7R/ X6S X5R/X7R/ X6S X5R/X7R/	Rated voltage 6.3V,10V 6.3V,10V	Capacitance range C≧0.1μF C≥1.0μF		X7R, X5 Rated vol. ≧100V	R, X6S D.F. ≦ ≤3%	≦6% ≦7.5%	Exception of D.F. ≦ 1206≥0.47μF 0805>0.1μF, 0603≥0.068μF		
		Size 0201 0402	Dielectric X5R/X7R/ X6S X5R/X7R/ X6S X5R/X7R/	Rated voltage 6.3V,10V 6.3V,10V	Capacitance range C≧0.1μF		vol.		-			
		Size 0201 0402	Dielectric X5R/X7R/ X6S X5R/X7R/ X6S X5R/X7R/	Rated voltage 6.3V,10V 6.3V,10V	Capacitance range C≧0.1μF		≧100V	≦3%	-	0805>0.1μF, 0603≧0.068μF		
		0201	X5R/X7R/ X6S X5R/X7R/ X6S X5R/X7R/	voltage 6.3V,10V 6.3V,10V	tance range C≧0.1µF		≥100V	≧370	≦7.5%	1 /		
		0201	X5R/X7R/ X6S X5R/X7R/ X6S X5R/X7R/	voltage 6.3V,10V 6.3V,10V	range C≧0.1μF					0204/50//): 0602 > 0.047::5:		
		0402	X6S X5R/X7R/ X6S X5R/X7R/	6.3V,10V	<u> </u>	Ш			≦6%	0201(50V); 0603≧0.047μF; 0805≧0.18μF;1206≧0.47μF		
			X5R/X7R/ X6S X5R/X7R/		C≧1.0µF	Ш	≧50V	≦3%	≦10%	1210≧4.7µF		
		0603		///	'				≦20%	0402≥0.1μF; 0603≥1μF; 0805≥1μF;1206≥4.7μF; 1210≥10μF TT series		
		0603		L 4 V	C≧22µF		35V	≦5%	≦20%	0603≧1μF; 0805≥2.2μF; 1210≧10μF		
			l X6S	6.3V,10V	C≧4.7µF				≦10%	0201≧0.01μF;0805≧1μF; 1210≧10μF		
				35V	C≧1.0µF				≦14%	0603≧0.33μF; 1206≧4.7μF		
		0805	X5R/X7R/ X6S	4V 6.3V	C≧47µF		25V	≦5%	≦15%	0402≧0.10μF;0603≧0.47μF;0805≧2.2 μF; 1206≧6.8μF ; 1210≧22μF; TT series		
			X5R/X7R/	6.3V	C≧22µF C≧47µF	Ш			≦20%	0402≧1µF		
	High	1206	NP0	3,000V	C≧47μF C≧1.5pF			≦5%	≦10%	0201≧0.01μF; 0402≧0.033μF; 0805≧0.68μF;1206≧2.2μF;1210≧4.7μF		
		TT18	Y5V Y5V	6.3V,10 6.3V	C≧2.2μF C≧10μF		16V		≦15%	0201≥0.1μF; 0402≥0.47μF; 0603≥0.68μF;0805≥2.2μF; 1206≥4.7μF; 1210≥22μF; TT series		
15	Temperature Load	. ,	Y5V % of rated	6.3V voltage fo	C≧22μF or below		10V	≦7.5%	≦15%	0201≥0.012μF 0402≥0.33μF; 0603≥0.33μF; 0805≥2.2μF; 1206≥2.2μF; 1210≥22μF; TT series		
'	(Endurance)	ran	ge.						≦20%	0201≧0.1μF; 0402≧1μF		
		Size	Dielectric	Rated voltage	Capaci- tance range		6.3V	≦15%	≦30%	0201≧0.1µF;0402≧1µF;0603≧10µF; 0805≧4.7µF; 1206≧47µF :1210≧100µF; TT series		
		0201	X5R/X7R/ X6S	16V	C≧0.1µF		4V	≦20%	-	-		
			X5R/X7R/	50V	C≧0.1µF		Y5V:					
		0402	X6S	10V~25V	C≧0.22µF		Rated vol.	D.F.≦		Exception of D.F. ≦		
			Y5V	16V	C≧0.47µF		≧50V	7.5%	10%	0603≧0.1μF; 0805≧0.47μF; 1206≧4.7μF		
		0603	X5R/X7R/ X6S	10V,50V	C≧1.0µF		35V	10%	-	-		
			Y5V	16V	C≧2.2µF				10%	0402≥0.047μF;0603≥0.1μF; 0805≥0.33μF;1206≥1μF; 1210≥4.7μF		
			X5R/X7R/ X6S	10~50V	C≧4.7µF		25V	7.5%	15%	0402≧0.068µF; 0603≧0.47µF; 1206≧4.7µF; 1210≧22µF		
		0805	X7R	50V	C≧2.2µF		16V		12.5%	0402≧0.068µF; 0603≧0.68µF		
				100V	C≧0.47µF		(C<1µF) 10%	20%	0402≧0.22µF		
		2220	Y5V X7R	16V 100V	C≧4.7μF C≧6.8μF		16V (C≧1.0µl	12.5%	6 20%	0603≧2.2μF; 0805≧3.3μF; 1206≧10μF; 1210≧22μF; 1812≧47μF		
			<u> </u>	<u> </u>	- 1		10V	20%	30%	0402≧0.47μF		
							6.3V	30%	+ -	 		

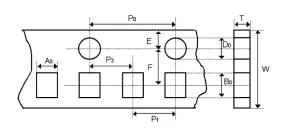




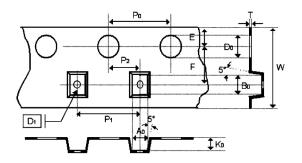
No	Item	Test Condition	Requirements				
			*I.R.: ≥10V, 1GΩ or 50 Ω-F whichever is smaller. Class II (X7R, X5R, X6S, Y5V)				
			Rated voltage	Insulation Resistance			
		,	100V: X7R				
	Lliab	temp.	50V: 0402≥0.1μF;0603≥1μF;0805≥1μF; 1206≥4.7μF;1210≥4.7μF				
	High Temperature		35V: 0603≥1μF; 0805≥2.2μF;1210≥10μF				
15	Load (Endurance		25V:0402≥1µF;0603≥2.2µF;0805≥2.2µF; 1206≥10µF;1210≥10µF	1GΩ or RxC≧10 Ω-F			
			16V:0402≥0.22µF;0603≥1µF;0805≥2.2µF; 1206≥10µF;1210≥47µF	whichever is smaller.			
			10V:0201≥47nF;0402≥0.47µF;0603≥0.47 µF;0805≥2.2µF;				
			1206≥4.7µF;1210≥47µF				
			6.3V ; 4V				

Appendixes

Tape & Reel Dimensions



The dimension of paper tape

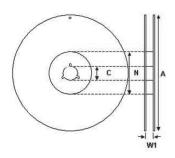


The dimension of plastic tape

Size	ize 0402		0402 0603 0805				1206			1210			1812		
Thick- ness	N	E	s, x	А	В	C, D, I	В	C, J, D	G,P	C, D	G, K	М	D, K	М	U
A ₀	0.62±0.05	0.7±0.10	1.02±0.05	1.5±0.1	1.5±0.1	<1.57	2±0.1	<1.85	<1.95	<2.97	<2.97	<2.97	<3.81	<3.81	<3.9
В0	1.12±0.05	1.2±0.10	1.8±0.05	2.3±0.1	2.3±0.1	<2.40	3.5±0.1	<3.46	<3.67	<3.73	<3.73	<3.73	<5.3	<5.3	<5.3
Т	0.6±0.05	0.7±0.10	0.95±0.05	0.75±0.05	0.95±0.05	0.23±0.05	0.95±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.23±0.05	0.25±0.05	0.25±0.05	0.25±0.05
К0	-	-	-	-	-	<2.5	-	<2.5	<2.5	<2.5	<2.5	<3	<2.5	<3	<3.5
W	8±0.1	8±0.10	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	8±0.1	12±0.2	12±0.2	12±0.2
P ₀	4±0.1	4±0.10	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1
10xP ₀	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.1	40±0.2
P1	2±0.05	2±0.05	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.1	4±0.10	4±0.1	8±0.1	8±0.1	8±0.1
P ₂	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05	2±0.05
D ₀	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.55±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.05	1.5±0.1
D ₁	-	-	-	-	-	1±0.1	-	1±0.1	1±0.1	1±0.1	1±0.1	1±0.1	1.5±0.1	1.5±0.1	1.5±0.1
E	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.05	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1	1.75±0.1
F	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	3.5±0.05	5.5±0.05	5.5±0.05	5.5±0.05



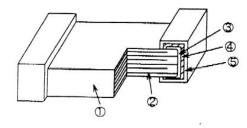




Size	0402, 0	1812		
Reel size	7"	7" 10"		7"
С	13 +0.5/-0.2	13 +0.5/-0.2	13 +0.5/-0.2	13 +0.5/-0.2
W1	8.4 +1.5/-0	8.4+1.5/-0	8.4 +1.5/-0	12.4+2.0/-0
Α	178 ±0.1	250 ±1	330 ±1	178 ±0.1
N	60 +1/-0	100 ±1	100 ±1	60 +1/-0

The dimension of reel

Constructions:



No.	Na	me	NP0* NPO, X7R, Y5			
1	Ceramic	material	BaTiO₃ based			
2	Inner el	ectrode	Ni			
3		Inner layer	Cu			
4	Termination	Middle layer	Ni			
5		Outer layer	Sn (Matt)			

Storage and handling conditions

- (1) To store products at 5°C to 40°C ambient temperature and 20 to 70%. related humidity conditions.
- (2) The product is recommended to be used within one year after shipment. Check solderability in case of shelf life extension is needed.

Cautions:

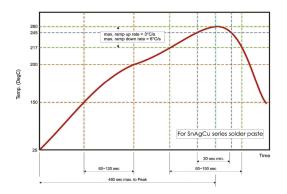
- a. The corrosive gas reacts on the terminal electrodes of capacitors, and results in the poor solderability. Do not store the capacitors in the ambience of corrosive gas (e.g., hydrogen sulfide, sulfur dioxide, chlorine, ammonia gas etc.)
- b. In corrosive atmosphere, solderability might be degraded, and silver migration might occur to cause low reliability.
- c. Due to the dewing by rapid humidity change, or the photochemical change of the terminal electrode by direct sunlight, the solderability and electrical performance may deteriorate. Do not store capacitors under direct sunlight or dewing condition. To store products on the shelf and avoid exposure to moisture.



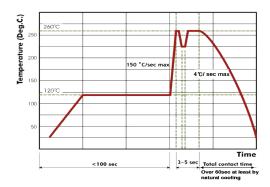


Recommended Soldering Conditions:

The lead-free termination MLCCs are not only to be used on SMT against lead-free solder paste, but also suitable against lead-containing solder paste. If the optimized solder joint is requested, increasing soldering time, temperature and concentration of N_2 within oven are recommended.



Recommended reflow soldering profile for SMT process with SnAgCu series solder paste.



Recommended wave soldering profile for SMT process with SnAgCu series solder.

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